ASSOCIATION CONNECTING LECTRONICS INDUSTRIES® Material Composi- © Copyright 2005. IPC, international and Pan-A	. Bannockb	urn. Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declara the declaration	ion of the s encompasse	ubstances es all lowe	within the manuf er level materials f	acturer lister or which the	d item. Note manufactu	e: if the item is ar irer has engineeri	assembly with lower	
					Type * Declaration Class * ute Class 6 - RoHS Yes/No, Homogeneous Mater				aterials and	ials and Mfg Information				
Supplier Information														
Company name* Co			Company unique ID			Unique ID Authority					Response Date*			
nsemi								2025-	2025-06-07					
ntact Name Title - Contact			ct	J			Phone - Contact*				Email - Contact*			
Product-Env-Stewards Product Envi			nviro Compliance			NA				Prod	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Repr			presentative			Phone - Representative*				Emai	Email - Representative*			
Product-Env-Stewards Product En			ct Enviro Compliance			NA				Prod	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item Number		Mfr Item Name			Effective Dat	e Version		Manufacturing Site		Weight*	UOM	Unit Type	
	MOC306	3SR2VM	6PW ZC TRIAC T&R VDE			2025-06-07			LITEONFG		464.903	mg	Each	
Manufacturing Proccess Informatio	n													
Terminal Plating / Grid Array Mater	erial Terminal Base		Iloy J-STD-020 MSL Rati		Rating	Peak Pro	cess Body T	ss Body Temperature Max Time at Peak		Peak Tempe	Temperature Number of Reflow Cycles			
Matte Tin (Sn) - annealed CU Alloy		U Alloy		1		260	С		30 seco		seconds 3			
Comments														
level 1 - maximum time at peak temperature	during sol	dering is 10-3	0 seconds											
For more information regarding material con	nposition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chror	HS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead b), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl thalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted								
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all							
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	f the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the mit Form to have the form returned to the Requester.											
Supplier Digital Signature Ra	stislav Drska	Le										

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Coupling Gel	0.4	mg	Supplier	Dimethyl Cyclosiloxanes	69430-24-6		0.04	mg
			Supplier	Trimethoxy(methyl)silane (C4H12O3Si)	1185-55-3		0.36	mg
Die	5.13	mg	Supplier	Silicon (Si)	7440-21-3		5.13	mg
Die Attach	0.3	mg	Supplier	Silver (Ag)	7440-22-4		0.225	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.075	mg
Lead Frame 10	101.703	mg	Supplier	Silver (Ag)	7440-22-4		0.407	mg
			Supplier	Zinc (Zn)	7440-66-6		0.203	mg
			Supplier	Iron (Fe)	7439-89-6		2.64	mg
			Supplier	Copper (Cu)	7440-50-8		98.3	mg
			Supplier	Phosphorus (P)	7723-14-0		0.153	mg
Mold Compound-White	327.22	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		81.805	mg
			В	Brominated Bisphenol A Diglycidyl Ether	40039-93-8		9.8166	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		44.1747	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		9.8166	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		163.61	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		17.9971	mg
Plating	28.5	mg	Supplier	Tin (Sn)	7440-31-5		28.5	mg
Wire Bond - Au	1.65	mg	Supplier	Gold (Au)	7440-57-5		1.65	mg